

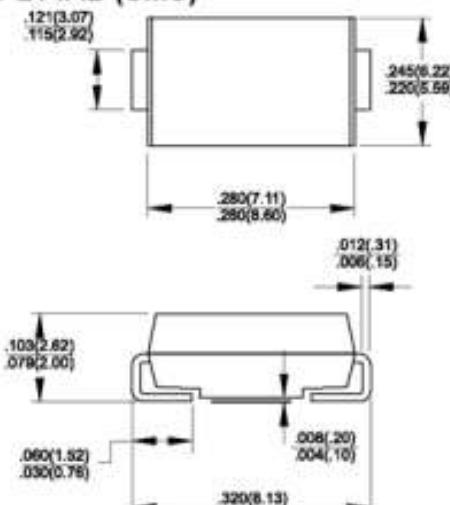
# S3A thru S3M



Surface Mount Glass Passivated Rectifiers  
Reverse Voltage 50 to 1000 Volts Forward Current 3.0 Amperes

## Features

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- For surface mounted applications
- Low profile package
- Built-in strain relief, ideal for automated placement
- Glass passivated chip junction

**DO-214AB (SMC)**

Dimensions in inches and (millimeters)

## Mechanical Data

- Case: JEDEC DO-214AB (SMC) molded plastic body over glass passivated chip
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- High temperature soldering:  
260°C/10 seconds at terminals
- Polarity: Color band denotes cathode end
- Weight: 0.009 ounce, 0.25 gram

## Maximum Ratings and Electrical Characteristics

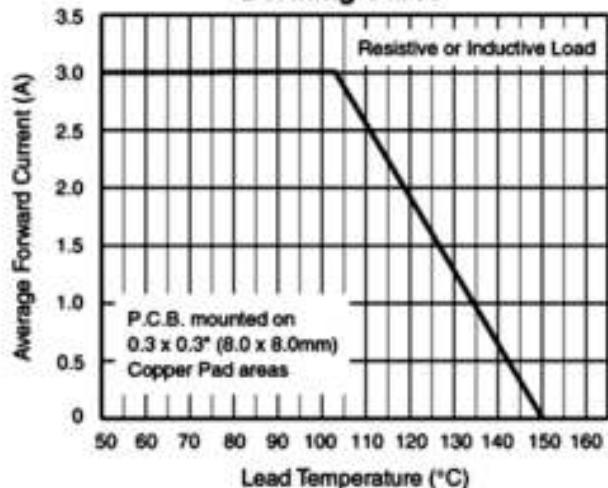
Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbols	S3A	S3B	S3D	S3G	S3J	S3K	S3M	Unit
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	Volts
Maximum RMS voltage	$V_{RMS}$	35	70	140	280	420	560	700	Volts
Maximum DC blocking voltage	$V_{DC}$	50	100	200	400	600	800	1000	Volts
Maximum average forward rectified current at $T_j=103^\circ\text{C}$ (1)	$I_{F(AV)}$					3.0			Amps
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method) $T_j=75^\circ\text{C}$	$I_{FSM}$					100.0			Amps
Maximum instantaneous forward voltage at 2.5A	$V_F$					1.15			Volts
Maximum DC reverse current @ $T_A=25^\circ\text{C}$ at rated DC blocking voltage @ $T_A=125^\circ\text{C}$	$I_R$					10.0			µA
Typical reverse recovery time at $I_f=0.5\text{A}$ , $I_{av}=1.0\text{A}$ , $I_{off}=0.25\text{A}$	$t_{rr}$					1.0			µS
Typical junction capacitance at 4.0V, 1MHz	$C_J$					60			pF
Typical thermal resistance (NOTE 1)	$R_{JA}$ $R_{UL}$					47			°C/W
Operating junction temperature range	$T_j$					-55 to +150			°C
Storage temperature range	$T_{STG}$					-55 to +150			°C

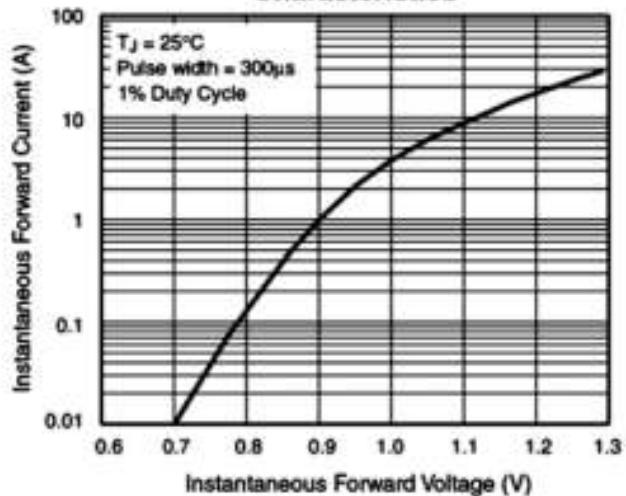
Notes: 1. Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.3 x 0.3" (8.0 x 8.0mm) copper pad areas

## RATINGS AND CHARACTERISTIC CURVES

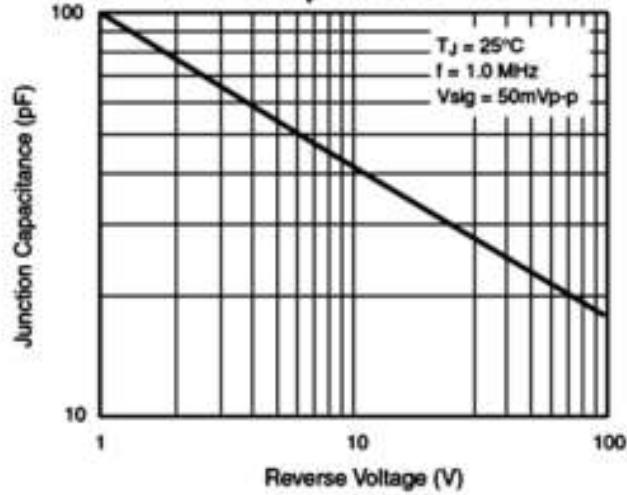
**Fig. 1 - Forward Current Derating Curve**



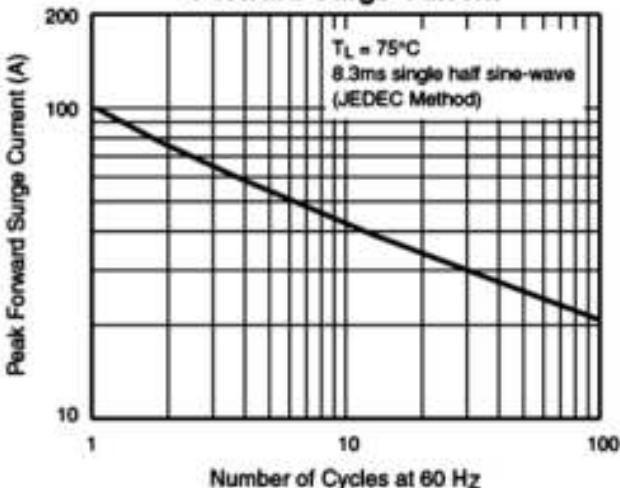
**Fig. 3 - Typical Instantaneous Forward Characteristics**



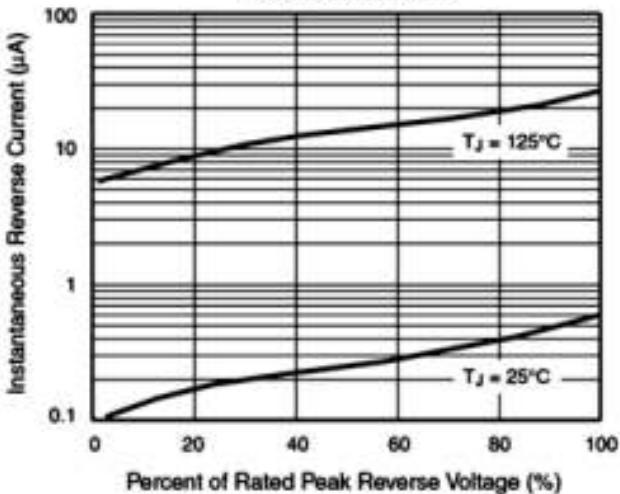
**Fig. 5 - Typical Junction Capacitance**



**Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current**



**Fig. 4 - Typical Reverse Characteristics**



**Fig. 6 - Typical Transient Thermal Impedance**

